

C0805X152K1RACTU

Aliases (C0805X152K1RAC7800) SMD Comm X7R Flex, Ceramic, 1,500 pF, 10%, 100 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 0805, 0.6 mm



Click here for the 3D model.

| General Information | |
|--------------------------|--|
| Series | SMD Comm X7R Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, FT-CAP, Temperature Stable |
| Features | FT-CAP, Temperature Stable |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 13 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

 Dimensions

 Chip Size
 0805

 L
 2mm +/-0.3mm

 W
 1.25mm +/-0.3mm

 T
 0.78mm +/-0.20mm

 S
 0.6mm MIN

 B
 0.5mm +/-0.25mm

Packaging Specifications

Packaging Packaging Quantity T&R, 180mm, Plastic Tape 4000

| Specifications | |
|--|--|
| Capacitance | 1,500 pF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Tolerance | 10% |
| Voltage DC | 100 VDC |
| Dielectric Withstanding Voltage | 250 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | X7R |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| Dissipation Factor | 2.5%1kHz1.0Vrms |
| Aging Rate | 3% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

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